

Thermopile Area Array Readout, Phase I

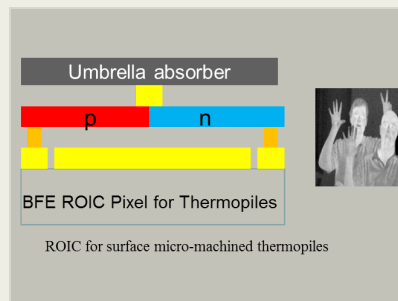
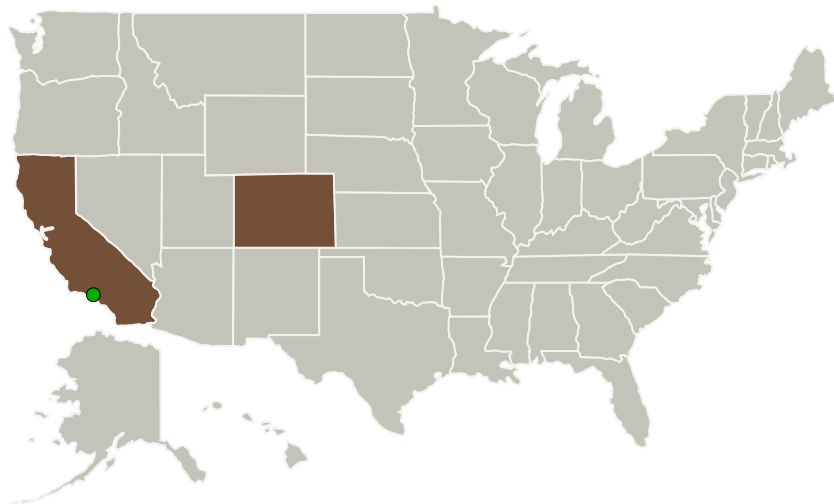
Completed Technology Project (2013 - 2013)



Project Introduction

NASA/JPL thermopile detector linear arrays, wire bonded to Black Forest Engineering (BFE) CMOS readout integrated circuits (ROICs), have been utilized in NASA missions such as the Mars Climate Sounder and the Diviner Lunar Radiometer Experiment. Linear array thermopile detectors are fabricated by bulk micro-machining. Surface micro-machined thermopiles are desirable for area array thermopiles because the architecture provides both high detector fill factor and circuit fill factor in the pixel. The Phase I effort designs an area array ROIC compatible with surface micro-machined thermopile detectors to meet requirements of future NASA thermal instruments requiring D-Star $> 4 \times 10^9$ Jones. Radiation hard-by-design will be utilized with 180 nm CMOS for low $1/f$ noise readout, operating temp 77-300 K, radiation hardness and noise immunity with on-ROIC ADC. Various pixel pitches and binning methods will be investigated to cover a desired wavelength detection range of $20\mu\text{m} - 100\mu\text{m}$. The Phase I ROIC array design, in a 128×128 or larger format, will be fabricated on Phase II.

Primary U.S. Work Locations and Key Partners



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Table of Contents

Project Introduction	1
Primary U.S. Work Locations and Key Partners	1
Project Transitions	2
Images	2
Organizational Responsibility	2
Project Management	2
Technology Maturity (TRL)	3
Technology Areas	3
Target Destinations	3

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Organizations Performing Work	Role	Type	Location
Black Forest Engineering, LLC	Lead Organization	Industry	Colorado Springs, Colorado
● Jet Propulsion Laboratory(JPL)	Supporting Organization	NASA Center	Pasadena, California

Primary U.S. Work Locations

California	Colorado
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Project Transitions

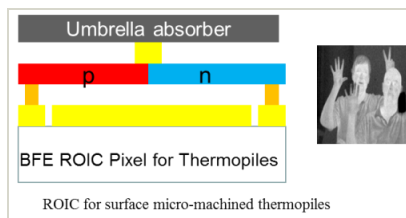
▶ **May 2013:** Project Start

✓ **November 2013:** Closed out

Closeout Documentation:

- Final Summary Chart(<https://techport.nasa.gov/file/139386>)

Images



Project Image

Thermopile Area Array Readout
(<https://techport.nasa.gov/image/135957>)

Organizational Responsibility

Responsible Mission Directorate:

Space Technology Mission Directorate (STMD)

Lead Organization:

Black Forest Engineering, LLC

Responsible Program:

Small Business Innovation Research/Small Business Tech Transfer

Project Management

Program Director:

Jason L Kessler

Program Manager:

Carlos Torrez

Principal Investigator:

Stephen Gaalema

Co-Investigator:

Stephen Gaalema

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Technology Maturity (TRL)

Start: **2**
Current: **3**
Estimated End: **3**



Technology Areas

Primary:

- TX02 Flight Computing and Avionics
 - └ TX02.1 Avionics Component Technologies
 - └ TX02.1.6 Radiation Hardened ASIC Technologies

Target Destinations

The Sun, Earth, The Moon, Mars, Others Inside the Solar System, Outside the Solar System